

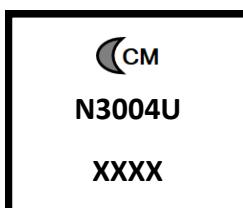
Description

The CMN3004U is the N-Channel enhancement mode power field effect transistors with high cell density, high voltage planar technology. This high density process and design have been optimized switching performance and especially tailored to minimize on-state resistance, .

Applications

- AC/DC load switch
- SMPS
- LED power

Marking Information



Marking Code = CMN3004U

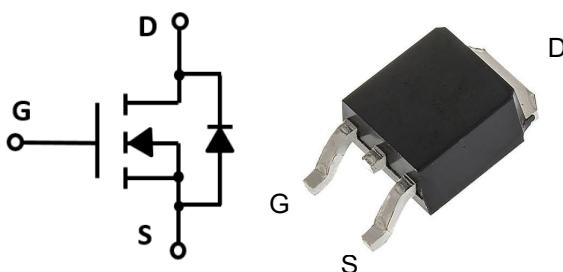
Date Code = XXXX

Features

- VDS: 30V
- ID : 80A
- RDS_{ON} (@VGS=10V) : < 5.5mΩ
- RDS_{ON} (@VGS=4.5V) : < 8.0mΩ
- High density cell design for extremely low RDS_{ON}
- Excellent on-resistance and DC current capability

Equivalent Circuit and Pin Configuration

TO-252



Ordering Information

Part Number	Packaging	Remark
CMN3004U	2500/Tape & Reel	ROHS

Absolute Maximum Ratings (T_c=25 °C unless otherwise noted)

Parameter	Symbol	Maximum	Unit
Drain-source Voltage	V _{DS}	30	V
Gate-source Voltage	V _{GС}	±20	V
Continuous Drain Current T _c =25°C	I _D	80	A
T _c =70°C		64	A
Pulsed Drain Current ⁽¹⁾	I _{DM}	320	A
Total Power Dissipation ⁽²⁾	P _D @ T _c =25°C	57	W
Thermal Resistance Junction-to-Case ⁽²⁾	R _{θJC}	2.2	°C/W
Junction and Storage Temperature Range	T _{J,TSTG}	-55 to +150	°C

Electrical Characteristics (T_c=25 °C unless otherwise noted)

Parameter	Symbol	Conditions	Min	Typ	Max	Units
Static Parameter						
Drain-Source Breakdown Voltage	BVDSS	V _{GS} =0V, I _D =250μA	30			V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =30V, V _{GS} =0V, T _c =25°C			1	μA
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V, V _{DS} =0V			±100	nA
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} , I _D =250μA	1.0		2.5	V
Static Drain-Source on-Resistance	R _{DS(on)}	V _{GS} =10V, I _D =20A		4.2	5.5	mΩ
		V _{GS} =4.5V, I _D =15A		5.7	8.0	
Diode Forward Voltage	V _{SD}	I _S =20A, V _{GS} =0V			1.2	V
Maximum Body-Diode Continuous Current	I _S				80	A
Dynamic Parameters						
Input Capacitance	C _{iss}	V _{DS} =15V, V _{GS} =0V, f=1MHz		2150		pF
Output Capacitance	C _{oss}			268		
Reverse Transfer Capacitance	C _{rss}			200		
Switching Parameters						
Total Gate Charge	Q _g	V _{GS} =10V, V _{DS} =15V, I _D =20A		42		nC
Gate Source Charge	Q _{gs}			5.9		
Gate Drain Charge	Q _{gd}			8.8		
Turn-on Delay Time	t _{D(on)}	V _{GS} =10V, V _{DD} =20V, R _L =1Ω, I _D =2A, R _{GEN} =3Ω		9		ns
Turn-on Rise Time	t _r			15.5		
Turn-off Delay Time	t _{D(off)}			29		
Turn-off Fall Time	t _f			9		

Noted: (1) Pulse Test: Pulse Width ≤ 300us, Duty cycle ≤ 2%.

(2) Device mounted on FR-4 PCB , 1 inch x 0.85 inch x 0.062 inch with 2oz. Copper , t ≤ 10s.

Typical Performance Characteristics

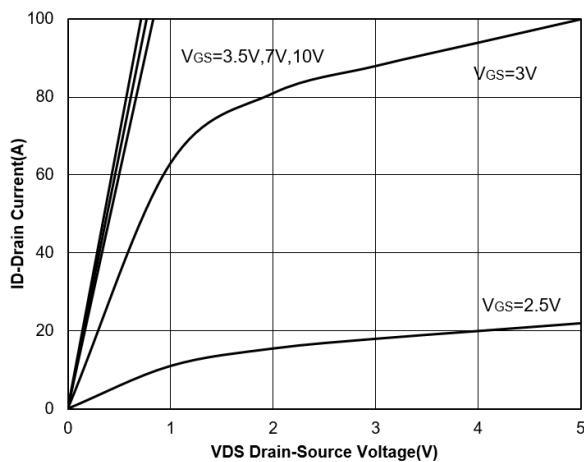


Figure 1. Output Characteristics

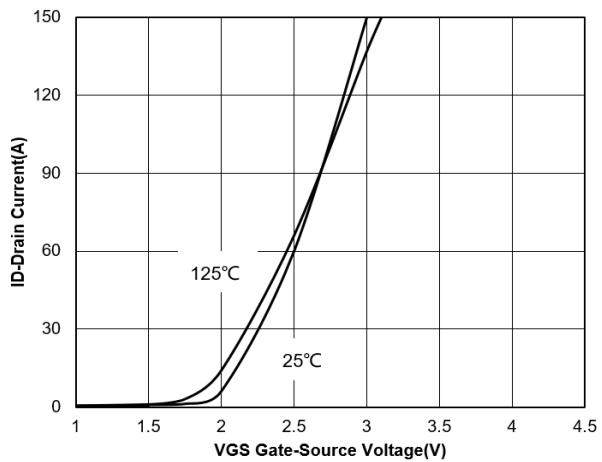


Figure 2. Transfer Characteristics

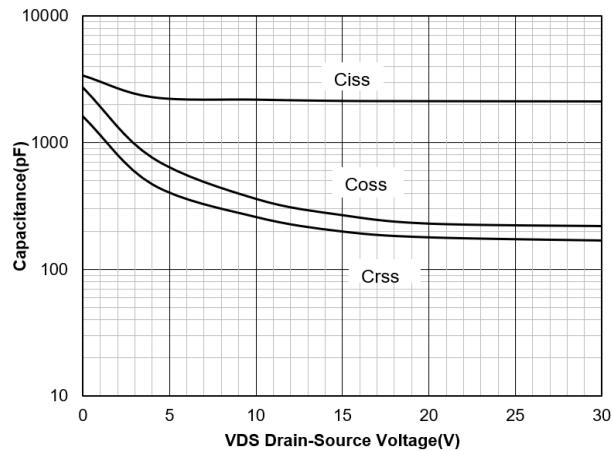


Figure 3. Capacitance Characteristics

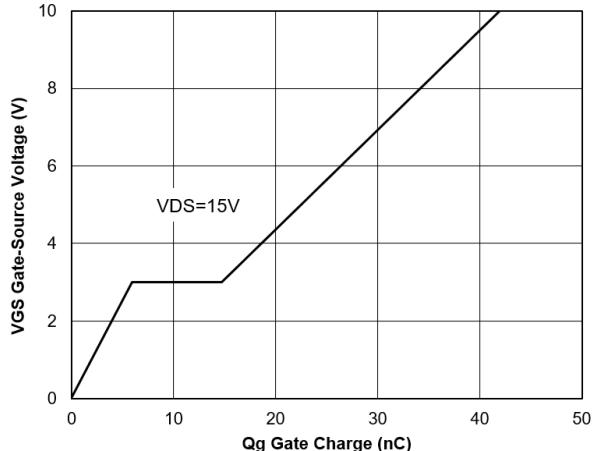


Figure 4. Gate Charge

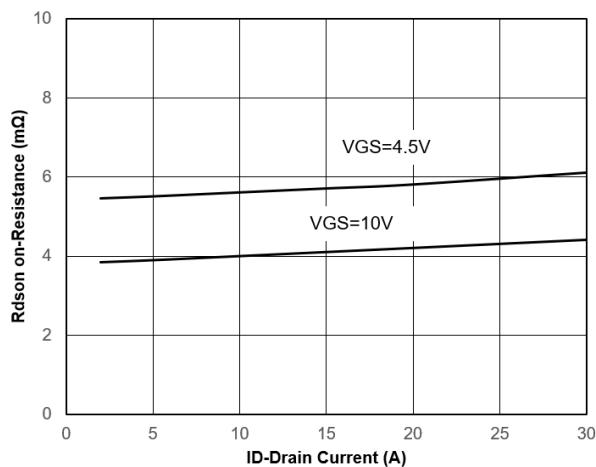


Figure 5. Drain-Source on Resistance

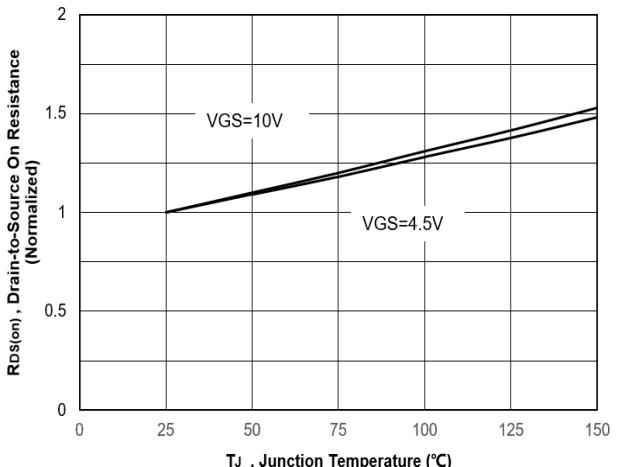


Figure 6. Normalized On-Resistance Vs. Temperature

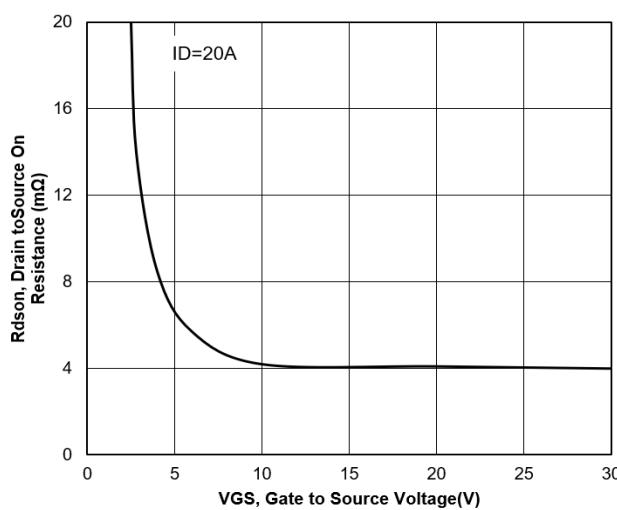


Figure 7. Typical Drain to Source ON Resistance
VS Gate Voltage and Drain Current

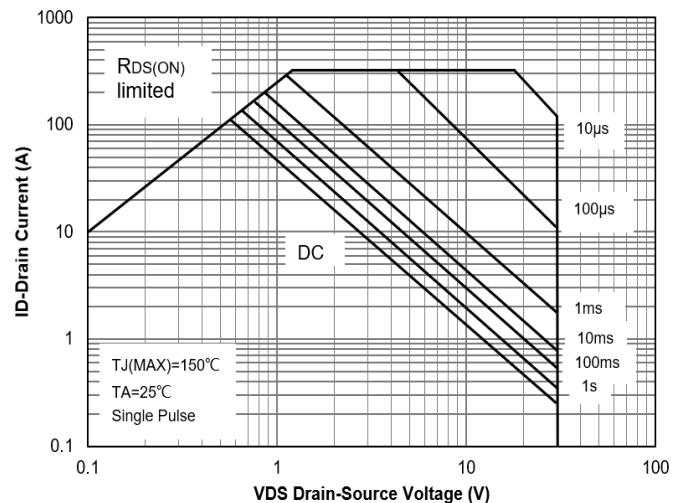


Figure 8. Safe Operation Area

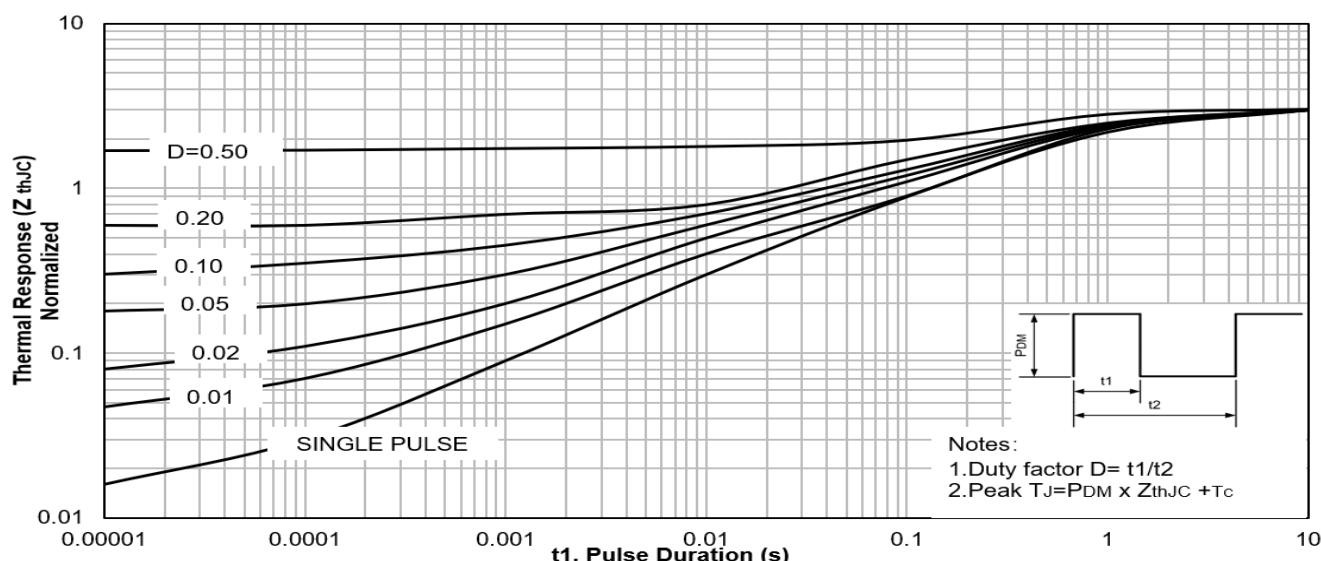


Figure 9. Maximum Effective Transient Thermal Impedance ,Junction-to-Case

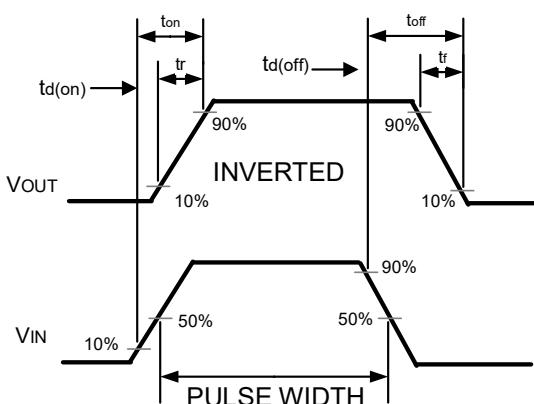
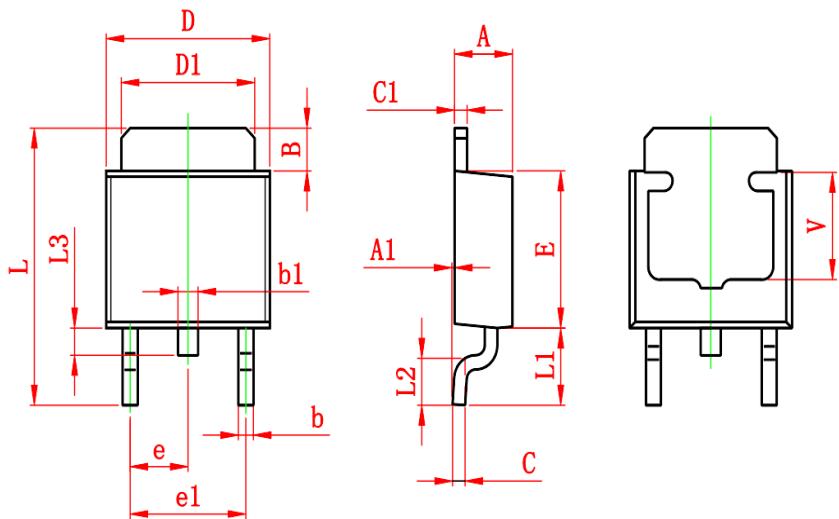


Figure 10. Switching wave

TO-252 Package Outline Drawing



Symbol	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A	2.200	2.400	0.087	0.094
A1	0.000	0.127	0.000	0.005
B	1.350	1.650	0.053	0.065
b	0.500	0.700	0.020	0.028
b1	0.700	0.900	0.028	0.035
c	0.430	0.580	0.017	0.023
c1	0.430	0.580	0.017	0.023
D	6.350	6.650	0.250	0.262
D1	5.200	5.400	0.205	0.213
E	5.400	5.700	0.213	0.224
e	2.300 TYP.		0.091 TYP.	
e1	4.500	4.700	0.177	0.185
L	9.500	9.900	0.374	0.390
L1	2.550	2.900	0.100	0.114
L2	1.400	1.780	0.055	0.070
L3	0.600	0.900	0.024	0.035
V	3.800 REF.		0.150 REF.	

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